

16-Bit, 500 kSPS PulSAR Dual, 2-Channel, Simultaneous Sampling ADC

Data Sheet **[AD7654](http://analog.com/ad7654?doc=ad7654.pdf)**

FEATURES

Dual, 16-bit, 2-channel simultaneous sampling ADC 16-bit resolution with no missing codes Throughput: 500 kSPS (normal mode) 444 kSPS (impulse mode) INL: ±3.5 LSB max (±0.0053% of full scale) SNR: 89 dB typ at 100 kHz THD: −100 dB at +100 kHz Analog input voltage range: 0 V to 5 V No pipeline delay Parallel and serial 5 V/3 V interface SPI®/QSPI™/MICROWIRE™/DSP compatible Single 5 V supply operation Power dissipation: 120 mW typical 2.6 mW at 10 kSPS Packages: 48-lead low profile quad flat package (LQFP) 48-lead lead frame chip scale package (LFCSP) Low cost APPLICATIONS

AC motor control 3-phase power control 4-channel data acquisition Uninterrupted power supplies Communications

GENERAL DESCRIPTION

The [AD7654 i](http://analog.com/ad7654?doc=ad7654.pdf)s a low cost, simultaneous sampling, dual-channel, 16-bit, charge redistribution SAR, analog-to-digital converter that operates from a single 5 V power supply. It contains two low noise, wide bandwidth, track-and-hold amplifiers that allow simultaneous sampling, a high speed 16-bit sampling ADC, an internal conversion clock, error correction circuits, and both serial and parallel system interface ports. Each track-and-hold has a multiplexer in front to provide a 4-channel input ADC. The A0 multiplexer control input allows the choice of simultaneously sampling input pairs INA1/INB1 (A0 = low) or INA2/INB2 (A0 = high). The part features a very high sampling rate mode (normal) and, for low power applications, a reduced power mode (impulse) where the power is scaled with the throughput. Operation is specified from −40°C to +85°C.

FUNCTIONAL BLOCK DIAGRAM

Table 1. PulSAR® Selection

PRODUCT HIGHLIGHTS

1. Simultaneous Sampling.

The [AD7654 f](http://analog.com/ad7654?doc=ad7654.pdf)eatures two sample-and-hold circuits that allow simultaneous sampling. It provides inputs for four channels.

- 2. Fast Throughput. The [AD7654 i](http://analog.com/ad7654?doc=ad7654.pdf)s a 500 kSPS, charge redistribution, 16-bit SAR ADC with internal error correction circuitry.
- 3. Superior INL and No Missing Codes. The [AD7654 h](http://analog.com/ad7654?doc=ad7654.pdf)as a maximum integral nonlinearity of 3.5 LSB with no missing 16-bit codes.
- 4. Single-Supply Operation. The [AD7654 o](http://analog.com/ad7654?doc=ad7654.pdf)perates from a single 5 V supply. In impulse mode, its power dissipation decreases with throughput.
- 5. Serial or Parallel Interface. Versatile parallel or 2-wire serial interface arrangement is compatible with both 3 V and 5 V logic.

Rev. D [Document Feedback](https://form.analog.com/Form_Pages/feedback/documentfeedback.aspx?doc=AD7654.pdf&product=AD7654&rev=D)

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REVISION HISTORY

12/15-Rev. C to Rev. D

$10/14$ —Rev. B to Rev. C

11/05-Rev. A to Rev. B

11/04-Rev. 0 to Rev. A

11/02-Revision 0: Initial Version

SPECIFICATIONS

AVDD = DVDD = 5 V, OVDD = 2.7 V to 5.25 V; all specifications T_{MIN} to T_{MAX} , unless otherwise noted.

Table 2.

¹ See th[e Analog Inputs s](#page-15-1)ection.

² Linearity is tested using endpoints, not best fit.
³ LSB means least significant bit. Within the 0 V to 5 V input range, one LSB is 76.294 μV.
⁴ See th[e Terminology s](#page-10-0)ection. These specifications do not include the

⁵ All specifications in dB are referred to as full-scale input, FS; tested with an input signal at 0.5 dB below full scale unless otherwise specified.
^{6 Parallel or serial 16-bit}

⁶ Parallel or serial 16-bit.

⁷ Conversion results are available immediately after completed conversion.
⁸ The maximum should be the minimum of 5.25 V and DVDD + 0.3 V.
⁹ In normal mode; tested in parallel reading mode.

10 In impulse mode; tested in parallel reading mode.

¹¹ Consult sales for extended temperature range.

TIMING SPECIFICATIONS

AVDD = DVDD = 5 V, OVDD = 2.7 V to 5.25 V; all specifications T_{MIN} to T_{MAX} , unless otherwise noted.

Table 3.

' In serial interface modes, the SYNC, SCLK, and SDOUT timings are defined with a maximum load C_L of 10 pF; otherwise C_L is 60 pF maximum.
² In serial master read during convert mode. Se[e Table 4 f](#page-5-0)or serial master r

Table 4. Serial Clock Timings in Master Read After Convert

DIVSCLK[1]		0	0			
DIVSCLK[0]	Symbol	0		0		Unit
SYNC to SCLK First Edge Delay Minimum	t_{25}	3	17	17	17	ns.
Internal SCLK Period Minimum	t_{26}	25	50	100	200	ns.
Internal SCLK Period Typical	t26	40	70	140	280	ns.
Internal SCLK High Minimum	t_{27}	12	22	50	100	ns
Internal SCLK Low Minimum	t_{28}		21	49	99	ns.
SDOUT Valid Setup Time Minimum	t_{29}	4	18	18	18	ns
SDOUT Valid Hold Time Minimum	tзо		4	30	80	ns
SCLK Last Edge to SYNC Delay Minimum	t_{31}			30	80	ns.
Busy High Width Maximum (Normal)	t_{35}	3.25	4.25	6.25	10.75	μs
Busy High Width Maximum (Impulse)	t_{35}	3.5	4.5	6.5	11	μs

ABSOLUTE MAXIMUM RATINGS

Table 5.

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

***IN SERIAL INTERFACE MODES, THE SYNC, SCLK, AND SDOUT TIMINGS ARE DEFINED WITH A MAXIMUM LOAD CL OF 10pF; OTHERWISE, THE LOAD IS 60pF MAXIMUM.** 03057-002

Figure 2. Load Circuit for Digital Interface Timing (SDOUT, SYNC, SCLK Outputs, $C_L = 10$ pF)

Figure 3. Voltage Reference Levels for Timing

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

¹ See th[e Analog Inputs s](#page-15-1)ection.

2 Specification is for device in free air:

48-lead LQFP: $\theta_{JA} = 91^{\circ}$ C/W, $\theta_{JC} = 30^{\circ}$ C/W.

³ Specification is for device in free air: 48-lead LFCSP; $\theta_{JA} = 26^{\circ}$ C/W.

PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

Table 6. Pin Function Descriptions

1 AI means analog input; DI means digital input; DI/O means bidirectional digital; DO means digital output; P means power.

TERMINOLOGY

Integral Nonlinearity Error (INL)

Linearity error refers to the deviation of each individual code from a line drawn from negative full scale through positive full scale. The point used as negative full scale occurs ½ LSB before the first code transition. Positive full scale is defined as a level 1½ LSB beyond the last code transition. The deviation is measured from the middle of each code to the true straight line.

Differential Nonlinearity Error (DNL)

In an ideal ADC, code transitions are 1 LSB apart. Differential nonlinearity is the maximum deviation from this ideal value. It is often specified in terms of resolution for which no missing codes are guaranteed.

Full-Scale Error

The last transition (from 111. . .10 to 111. . .11) should occur for an analog voltage 1½ LSB below the nominal full scale (4.999886 V for the 0 V to 5 V range). The full-scale error is the deviation of the actual level of the last transition from the ideal level.

Unipolar Zero Error

The first transition should occur at a level ½ LSB above analog ground (76.29 μV for the 0 V to 5 V range). The unipolar zero error is the deviation of the actual transition from that point.

Signal-to-Noise Ratio (SNR)

SNR is the ratio of the rms value of the actual input signal to the rms sum of all other spectral components below the Nyquist frequency, excluding harmonics and dc. The value for SNR is expressed in decibels.

Total Harmonic Distortion (THD)

THD is the ratio of the rms sum of the first five harmonic components to the rms value of a full-scale input signal and is expressed in decibels.

Signal-to-Noise and Distortion Ratio (SINAD)

SINAD is the ratio of the rms value of the actual input signal to the rms sum of all other spectral components below the Nyquist frequency, including harmonics but excluding dc. The value for SINAD is expressed in decibels.

Spurious-Free Dynamic Range (SFDR)

The difference, in decibels, between the rms amplitude of the input signal and the peak spurious signal.

Effective Number of Bits (ENOB)

ENOB is a measurement of the resolution with a sine wave input. It is related to SINAD and expressed in bits by

 $ENOB = ((SIMAD_{dB} - 1.76)/6.02)$

and is expressed in bits.

Aperture Delay

Aperture delay is a measure of acquisition performance and is measured from the falling edge of the CNVST input to when the input signals are held for a conversion.

Transient Response

The time required for th[e AD7654](http://analog.com/ad7654?doc=ad7654.pdf) to achieve its rated accuracy after a full-scale step function is applied to its input.

TYPICAL PERFORMANCE CHARACTERISTICS

Figure 17. Typical Delay vs. Load Capacitance C_L

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03057-015

03057-015

03057-016

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APPLICATIONS INFORMATION **CIRCUIT INFORMATION**

The [AD7654 i](http://analog.com/ad7654?doc=ad7654.pdf)s a very fast, low power, single-supply, precise, simultaneous sampling 16-bit ADC.

Th[e AD7654 p](http://analog.com/ad7654?doc=ad7654.pdf)rovides the user with two on-chip, track-and-hold, successive approximation ADCs that do not exhibit any pipeline or latency, making it ideal for multiple multiplexed channel applications. Th[e AD7654 c](http://analog.com/ad7654?doc=ad7654.pdf)an also be used as a 4-channel ADC with two pairs simultaneously sampled.

The [AD7654](http://analog.com/ad7654?doc=ad7654.pdf) can be operated from a single 5 V supply and be interfaced to either 5 V or 3 V digital logic. It is housed in a 48-lead LQFP or tiny 48-lead LFCSP that combines space savings and allows flexible configurations as either a serial or parallel interface. The [AD7654 i](http://analog.com/ad7654?doc=ad7654.pdf)s pin-to-pin compatible with PulSAR ADCs.

MODES OF OPERATION

The [AD7654 f](http://analog.com/ad7654?doc=ad7654.pdf)eatures two modes of operation, normal and impulse. Each of these modes is more suitable for specific applications.

Normal mode is the fastest mode (500 kSPS). Except when it is powered down (PD = HIGH), the power dissipation is almost independent of the sampling rate.

Impulse mode, the lowest power dissipation mode, allows power saving between conversions. The maximum throughput in this mode is 444 kSPS. When operating at 10 kSPS, for example, it typically consumes only 2.6 mW. This feature makes the [AD7654 i](http://analog.com/ad7654?doc=ad7654.pdf)deal for battery-powered applications.

TRANSFER FUNCTIONS

The [AD7654](http://analog.com/ad7654?doc=ad7654.pdf) data format is straight binary. The ideal transfer characteristic for th[e AD7654](http://analog.com/ad7654?doc=ad7654.pdf) is shown i[n Figure 18](#page-13-4) an[d Table 7.](#page-13-5) The LSB size is $2 \times V_{REF}/65536$, which is about 76.3 μ V.

Table 7. Output Codes and Ideal Input Voltages

¹ This is also the code for overrange analog input

(VINx – VINxN above 2 × (VREF − VREFGND)).

² This is also the code for underrange analog input (V_{INx} below V_{INxN}).

NOTES

1. SEE VOLTAGE REFERENCE INPUT SECTION.
2. WITH THE RECOMMENDED VOLTAGE REFERENCES, C_{REF} IS 47µF. SEE VOLTAGE REFERENCE INPUT SECTION.
3. OPTIONAL CIRCUITRY FOR HARDWARE GAIN CALIBRATION.
4. THE AD8021 IS RECOMMENDED. SE

5. SEE ANALOG INPUTS SECTION.
6. OPTIONAL, SEE POWER <u>SUPPL</u>Y SECTION.
7. OPTIONAL LOW JITTER CNVST. SEE CONVERSION CONTROL SECTION.

Figure 19. Typical Connection Diagram (Serial Interface)

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TYPICAL CONNECTION DIAGRAM

[Figure 19 s](#page-14-0)hows a typical connection diagram for the [AD7654.](http://analog.com/ad7654?doc=ad7654.pdf) Different circuitry shown on this diagram is optional and is discussed in the following sections.

ANALOG INPUTS

[Figure 20 s](#page-15-4)hows a simplified analog input section of th[e AD7654.](http://analog.com/ad7654?doc=ad7654.pdf)

Figure 20. Simplified Analog Input

The diodes shown i[n Figure 20](#page-15-4) provide ESD protection for the inputs. Care must be taken to ensure that the analog input signal never exceeds the absolute ratings on these inputs. This causes these diodes to become forward biased and start conducting current. These diodes can handle a forward-biased current of 120 mA maximum. This condition can eventually occur when the input buffers (U1) or (U2) supplies are different from AVDD. In such a case, an input buffer with a short-circuit current limitation can be used to protect the device.

This analog input structure allows the sampling of the differential signal between INx and INxN. Unlike other converters, the INxN is sampled at the same time as the INx input. By using these differential inputs, small signals common to both inputs are rejected.

During the acquisition phase, for ac signals, th[e AD7654 b](http://analog.com/ad7654?doc=ad7654.pdf)ehaves like a one-pole RC filter consisting of the equivalent resistance RA, R_B, and C_s. The resistors R_A and R_B are typically 500 Ω and are a lumped component made up of some serial resistors and the on resistance of the switches. The capacitor C_s is typically 32 pF and is mainly the ADC sampling capacitor. This one-pole filter with a typical −3 dB cutoff frequency of 10 MHz reduces undesirable aliasing effects and limits the noise coming from the inputs.

Because the input impedance of the [AD7654 i](http://analog.com/ad7654?doc=ad7654.pdf)s very high, the [AD7654 c](http://analog.com/ad7654?doc=ad7654.pdf)an be driven directly by a low impedance source without gain error. To further improve the noise filtering of the [AD7654 a](http://analog.com/ad7654?doc=ad7654.pdf)nalog input circuit, an external one-pole RC filter between the amplifier output and the ADC input, as shown in [Figure 19,](#page-14-0) can be used. However, the source impedance has to be kept low because it affects the ac performance, especially the total harmonic distortion. The maximum source impedance depends on the amount of total harmonic distortion (THD) that can be tolerated. The THD degrades as the source impedance increases.

INPUT CHANNEL MULTIPLEXER

The [AD7654](http://analog.com/ad7654?doc=ad7654.pdf) allows the choice of simultaneously sampling the inputs pairs INA1/INB1 or INA2/INB2 with the A0 multiplexer input. When A0 is low, the input pairs INA1/INB1 are selected, and when A0 is high, the input pairs INA2/INB2 are selected. Note that INAx is always converted before INBx regardless of the state of the digital interface channel selection A/B pin. Also, note that the channel selection control A0 should not be changed during the acquisition phase of the converter. Refer to the [Conversion Control s](#page-17-0)ection an[d Figure 23 f](#page-17-3)or timing details.

DRIVER AMPLIFIER CHOICE

Although th[e AD7654 i](http://analog.com/ad7654?doc=ad7654.pdf)s easy to drive, the driver amplifier needs to meet at least the following requirements:

- For multichannel, multiplexed applications, the driver amplifier and th[e AD7654](http://analog.com/ad7654?doc=ad7654.pdf) analog input circuit together must be able to settle for a full-scale step of the capacitor array at a 16-bit level (0.0015%). In the amplifier's data sheet, the settling at 0.1% or 0.01% is more commonly specified. It can significantly differ from the settling time at a 16-bit level and, therefore, it should be verified prior to the driver selection.
- The noise generated by the driver amplifier needs to be kept as low as possible to preserve the SNR and transition noise performance of the [AD7654.](http://analog.com/ad7654?doc=ad7654.pdf) The noise coming from the driver is filtered by the [AD7654](http://analog.com/ad7654?doc=ad7654.pdf) analog input circuit one-pole low-pass filter made by R_A, R_B, and C_s. The SNR degradation due to the amplifier is

$$
SNR_{LOS} = 20 \log \left(\frac{56}{\sqrt{56^2 + \frac{\pi}{2} f_{-3\text{dB}} (Ne_N)^2}} \right)
$$

where:

 $f_{-3 dB}$ is the $-3 dB$ input bandwidth in MHz of the [AD7654](http://analog.com/ad7654?doc=ad7654.pdf) (10 MHz) or the cutoff frequency of the input filter, if any is used.

N is the noise factor of the amplifier (1 if in buffer configuration).

eN is the equivalent input noise voltage of the op amp in nV/√Hz.

For instance, a driver like th[e AD8021](http://analog.com/ad8021?doc=ad7654.pdf) with an equivalent input noise of 2 nV/ \sqrt{Hz} , configured as a buffer, and thus with a noise gain of +1, degrades the SNR by only 0.06 dB with the filter i[n Figure 19,](#page-14-0) and by 0.10 dB without.

 The driver needs to have a THD performance suitable to that of the [AD7654.](http://analog.com/ad7654?doc=ad7654.pdf)

Th[e AD8021 m](http://analog.com/ad8021?doc=ad7654.pdf)eets these requirements and is usually appropriate for almost all applications. The [AD8021 n](http://analog.com/ad8021?doc=ad7654.pdf)eeds an external compensation capacitor of 10 pF. This capacitor should have good linearity as an NPO ceramic or mica type. The [AD8022](http://analog.com/ad8022?doc=ad7654.pdf) can be used where a dual version is needed and a gain of +1 is used.

The [AD829 i](http://analog.com/ad829?doc=ad7654.pdf)s another alternative where high frequency (above 100 kHz) performance is not required. In a gain of +1, it requires an 82 pF compensation capacitor.

The [AD8610 i](http://analog.com/ad8610?doc=ad7654.pdf)s another option where low bias current is needed in low frequency applications.

Refer t[o Table 8](#page-16-3) for some recommended op amps.

Table 8. Recommended Driver Amplifiers

VOLTAGE REFERENCE INPUT

The [AD7654 r](http://analog.com/ad7654?doc=ad7654.pdf)equires an external 2.5 V reference. The reference input should be applied to REF, REFA, and REFB. The voltage reference input REF of the [AD7654 h](http://analog.com/ad7654?doc=ad7654.pdf)as a dynamic input impedance; it should therefore be driven by a low impedance source with an efficient decoupling. This decoupling depends on the choice of the voltage reference but usually consists of a 1 μF ceramic capacitor and a low ESR tantalum capacitor connected to the REFA, REFB, and REFGND inputs with minimum parasitic inductance. A value of 47 μF is an appropriate value for the tantalum capacitor when using one of the recommended reference voltages:

- The low noise, low temperature drif[t AD780,](http://analog.com/ad780?doc=ad7654.pdf) [ADR421,](http://analog.com/adr421?doc=ad7654.pdf) and [ADR431](http://analog.com/adr431?doc=ad7654.pdf) voltage reference.
- The low cost [AD1582](http://analog.com/ad1582?doc=ad7654.pdf) voltage reference.

For applications using multipl[e AD7654s](http://analog.com/ad7654?doc=ad7654.pdf) with one voltage reference source, it is recommended that the reference source drives each ADC in a star configuration with individual decoupling placed as close as possible to the REF/REFGND inputs. Also, it is recommended that a buffer, such as the [AD8031/](http://analog.com/ad8031?doc=ad7654.pdf)[AD8032,](http://analog.com/ad8032?doc=ad7654.pdf) be used in this configuration.

Take care with the reference temperature coefficient of the voltage reference, which directly affects the full-scale accuracy if this parameter is applicable. For instance, a 15 ppm/°C tempco of the reference changes the full-scale accuracy by 1 LSB/°C.

POWER SUPPLY

The [AD7654 u](http://analog.com/ad7654?doc=ad7654.pdf)ses three sets of power supply pins: an analog 5 V supply AVDD, a digital 5 V core supply DVDD, and a digital input/output interface supply OVDD. The OVDD supply allows direct interface with any logic working between 2.7 V and DVDD + 0.3 V. To reduce the number of supplies needed, the digital core (DVDD) can be supplied through a simple RC filter from the analog supply, as shown i[n Figure 19.](#page-14-0) Th[e AD7654](http://analog.com/ad7654?doc=ad7654.pdf) AVDD and DVDD supplies are independent of power supply sequencing. To ensure the device is free from supply voltage induced latch-up, OVDD must never exceed DVDD by greater than 0.3 V. Additionally, it is very insensitive to power supply variations over a wide frequency range, as shown in [Figure 21.](#page-16-4)

POWER DISSIPATION

In impulse mode, the [AD7654 a](http://analog.com/ad7654?doc=ad7654.pdf)utomatically reduces its power consumption at the end of each conversion phase. During the acquisition phase, the operating currents are very low, which allows significant power savings when the conversion rate is reduced, as shown i[n Figure 22.](#page-17-5) This feature makes th[e AD7654](http://analog.com/ad7654?doc=ad7654.pdf) ideal for very low power battery applications.

Note that the digital interface remains active even during the acquisition phase. To reduce the operating digital supply currents even further, the digital inputs need to be driven close to the power rails (that is, DVDD and DGND), and OVDD should not exceed DVDD by more than 0.3 V.

CONVERSION CONTROL

[Figure 23 s](#page-17-3)hows the detailed timing diagrams of the conversion process. Th[e AD7654 i](http://analog.com/ad7654?doc=ad7654.pdf)s controlled by the signal $\overline{\text{CNVST}}$, which initiates conversion. Once initiated, it cannot be restarted or aborted, even by the power-down input, PD, until the conversion is complete. The $\overline{\text{CNVST}}$ signal operates independently of the $\overline{\text{CS}}$ and RD signals.

Although $\overline{\text{CNVST}}$ is a digital signal, it should be designed with special care with fast, clean edges and levels, and with minimum overshoot and undershoot or ringing.

For applications where the SNR is critical, the CNVST signal should have very low jitter. Some solutions to achieve this are to use a dedicated oscillator for CNVST generation or, at least, to clock it with a high frequency, low jitter clock, as shown in [Figure 19.](#page-14-0)

In impulse mode, conversions can be automatically initiated. If CNVST is held low when BUSY is low, the [AD7654](http://analog.com/ad7654?doc=ad7654.pdf) controls the acquisition phase and automatically initiates a new conversion. By keeping CNVST low, th[e AD7654 k](http://analog.com/ad7654?doc=ad7654.pdf)eeps the conversion process running by itself. Note that the analog input has to be settled when BUSY goes low. Also, at power-up, CNVST should

be brought low once to initiate the conversion process. In this mode, the [AD7654](http://analog.com/ad7654?doc=ad7654.pdf) may sometimes run slightly faster than the guaranteed limits of 444 kSPS in impulse mode. This feature does not exist in normal mode.

DIGITAL INTERFACE

The [AD7654 h](http://analog.com/ad7654?doc=ad7654.pdf)as a versatile digital interface; it can be interfaced with the host system by using either a serial or parallel interface. The serial interface is multiplexed on the parallel data bus. The [AD7654 d](http://analog.com/ad7654?doc=ad7654.pdf)igital interface accommodates either 3 V or 5 V logic by simply connecting the OVDD supply pin of th[e AD7654 t](http://analog.com/ad7654?doc=ad7654.pdf)o the host system interface digital supply.

The two signals \overline{CS} and \overline{RD} control the interface. When at least one of these signals is high, the interface outputs are in high impedance. Usually, CS allows the selection of each [AD7654](http://analog.com/ad7654?doc=ad7654.pdf) in multicircuit applications and is held low in a single [AD7654](http://analog.com/ad7654?doc=ad7654.pdf) design. $\overline{\text{RD}}$ is generally used to enable the conversion result on the data bus. In parallel mode, signal A/\overline{B} allows the choice of reading either the output of Channel A or Channel B, whereas in serial mode, signal A/B controls which channel is output first.

[Figure 24 d](#page-17-4)etails the timing when using the RESET input. Note the current conversion, if any, is aborted and the data bus is high impedance while RESET is high.

PARALLEL INTERFACE

The [AD7654 i](http://analog.com/ad7654?doc=ad7654.pdf)s configured to use the parallel interface when SER/PAR is held low.

Master Parallel Interface

Data can be read continuously by tying \overline{CS} and \overline{RD} low, thus requiring minimal microprocessor connections. However, in this mode, the data bus is always driven and cannot be used in shared bus applications (unless the device is held in RESET). [Figure 25 d](#page-18-0)etails the timing for this mode.

Figure 25. Master Parallel Data Timing for Continuous Read

Slave Parallel Interface

In slave parallel reading mode, the data can be read either after each conversion, which is during the next acquisition phase or during the other channel's conversion, or during the following conversion, as shown i[n Figure 26](#page-18-2) an[d Figure 27,](#page-18-3) respectively. When the data is read during the conversion, however, it is recommended that it is read only during the first half of the conversion phase. This avoids any potential feedthrough between voltage transients on the digital interface and the most critical analog conversion circuitry.

Figure 27. Slave Parallel Data Timing for a Read During Conversion

8-Bit Interface (Master or Slave)

The BYTESWAP pin allows a glueless interface to an 8-bit bus. As shown in [Figure 28,](#page-18-4) the LSB byte is output on D[7:0] and the MSB is output on D[15:8] when BYTESWAP is low. When BYTESWAP is high, the LSB and MSB bytes are swapped, the LSB is output on D[15:8], and the MSB is output on D[7:0]. By connecting BYTESWAP to an address line, the 16-bit data can be read in two bytes on either D[15:8] or D[7:0].

Channel A/B Output

The A/\overline{B} input controls which channel's conversion results (INAx or INBx) are output on the data bus. The functionality of A/B is detailed i[n Figure 29.](#page-18-1) When high, the data from Channel A is available on the data bus. When low, the data from Channel B is available on the bus. Note that Channel A can be read immediately after conversion is done (\overline{EOC}) , while Channel B is still in its converting phase. However, in any of the serial reading modes, Channel A data is updated only after Channel B is converted.

Figure 29. $A\sqrt{B}$ Channel Reading

SERIAL INTERFACE

The [AD7654 i](http://analog.com/ad7654?doc=ad7654.pdf)s configured to use the serial interface when the SER/PAR is held high. Th[e AD7654](http://analog.com/ad7654?doc=ad7654.pdf) outputs 32 bits of data, MSB first, on the SDOUT pin. The order of the channels being output is also controlled by A/B . When high, Channel A is output first; when low, Channel B is output first. This data is synchronized with the 32 clock pulses provided on the SCLK pin.

MASTER SERIAL INTERFACE Internal Clock

The [AD7654 i](http://analog.com/ad7654?doc=ad7654.pdf)s configured to generate and provide the serial data clock SCLK when the EXT/INT pin is held low. The [AD7654 a](http://analog.com/ad7654?doc=ad7654.pdf)lso generates a SYNC signal to indicate to the host when the serial data is valid. The serial clock SCLK and the SYNC signal can be inverted if desired. The output data is valid on both the rising and falling edge of the data clock. Depending on RDC/SDIN input, the data can be read after each conversion or during the following conversion. [Figure 30 a](#page-20-0)n[d Figure 31](#page-20-1) show the detailed timing diagrams of these two modes.

Usually, because the [AD7654 i](http://analog.com/ad7654?doc=ad7654.pdf)s used with a fast throughput, the master-read-during-convert mode is the most recommended serial mode when it can be used. In this mode, the serial clock and data toggle at appropriate instants, which minimizes potential feedthrough between digital activity and the critical conversion decisions. The SYNC signal goes low after the LSB of each channel has been output. Note that in this mode, the SCLK period changes because the LSBs require more time to settle, and the SCLK is derived from the SAR conversion clock.

Note that in the master-read-after-convert mode, unlike in other modes, the signal BUSY returns low after the 32 data bits are pulsed out and not at the end of the conversion phase, which results in a longer BUSY width. One advantage of using this mode is that it can accommodate slow digital hosts because the serial clock can be slowed down by using DIVSCLK[1:0] inputs. Refer t[o Table 4 f](#page-5-0)or the timing details.

Figure 31. Master Serial Data Timing for Reading (Read Previous Conversion During Convert)

AD7654 Data Sheet

SLAVE SERIAL INTERFACE

External Clock

The [AD7654 i](http://analog.com/ad7654?doc=ad7654.pdf)s configured to accept an externally supplied serial data clock on the SCLK pin when the EXT/INT pin is held high. In this mode, several methods can be used to read the data. The external serial clock is gated by \overline{CS} . When both \overline{CS} and \overline{RD} are low, the data can be read after each conversion or during the following conversion. The external clock can be either a continuous or discontinuous clock. A discontinuous clock can be either normally high or normally low when inactive. [Figure 33 a](#page-22-0)n[d Figure 34 s](#page-22-1)how the detailed timing diagrams of these methods.

While th[e AD7654 i](http://analog.com/ad7654?doc=ad7654.pdf)s performing a bit decision, it is important that voltage transients not occur on digital input/output pins or degradation of the conversion result may occur. This is particularly important during the second half of the conversion phase of each channel because the [AD7654 p](http://analog.com/ad7654?doc=ad7654.pdf)rovides error correction circuitry that can correct for an improper bit decision made during the first half of the conversion phase. For this reason, it is recommended that when an external clock is provided, it is a discontinuous clock that toggles only when BUSY is low or, more importantly, that it does not transition during the latter half of EOC high.

External Discontinuous Clock Data Read After Convert

Although the maximum throughput cannot be achieved in this mode, it is the most recommended of the serial slave modes. [Figure 33 s](#page-22-0)hows the detailed timing diagrams of this method. After a conversion is complete, indicated by BUSY returning low, the conversion results can be read while both $\overline{\text{CS}}$ and $\overline{\text{RD}}$ are low. Data is shifted out from both channels MSB first, with 32 clock pulses and is valid on both rising and falling edges of the clock.

One advantage of this method is that conversion performance is not degraded because there are no voltage transients on the digital interface during the conversion process. Another advantage is the ability to read the data at any speed up to 40 MHz, which accommodates both a slow digital host interface and the fastest serial reading.

Finally, in this mode only, the [AD7654 p](http://analog.com/ad7654?doc=ad7654.pdf)rovides a daisy-chain feature using the RDC/SDIN (serial data in) input pin for cascading multiple converters together. This feature is useful for reducing component count and wiring connections when it is desired, as in isolated multiconverter applications.

An example of the concatenation of two devices is shown in [Figure 32.](#page-21-1) Simultaneous sampling is possible by using a common CNVST signal. Note that the RDC/SDIN input is latched on the edge of SCLK opposite the one used to shift out the data on SDOUT. Therefore, the MSB of the upstream converter follows the LSB of the downstream converter on the next SCLK cycle. The SDIN input should be tied either high or low on the most upstream converter in the chain.

Figure 32. Tw[o AD7654 D](http://analog.com/ad7654?doc=ad7654.pdf)evices in a Daisy-Chain Configuration

External Clock Data Read Previous During Convert

[Figure 34 s](#page-22-1)hows the detailed timing diagrams of this method. During a conversion, while both \overline{CS} and \overline{RD} are low, the result of the previous conversion can be read. The data is shifted out MSB first with 32 clock pulses and is valid on both the rising and falling edges of the clock. The 32 bits have to be read before the current conversion is completed; otherwise, RDERROR is pulsed high and can be used to interrupt the host interface to prevent incomplete data reading. There is no daisy-chain feature in this mode, and RDC/SDIN input should always be tied either high or low.

To reduce performance degradation due to digital activity, a fast discontinuous clock (at least 32 MHz in impulse mode and 40 MHz in normal mode) is recommended to ensure that all of the bits are read during the first half of each conversion phase $(EOC high, t₁₁, t₁₂).$

It is also possible to begin to read data after conversion and continue to read the last bits after a new conversion has been initiated. This allows the use of a slower clock speed like 26 MHz in impulse mode and 30 MHz in normal mode.

Figure 33. Slave Serial Data Timing for Reading (Read After Convert)

Figure 34. Slave Serial Data Timing for Reading (Read Previous Conversion During Convert)

MICROPROCESSOR INTERFACING

The [AD7654 i](http://analog.com/ad7654?doc=ad7654.pdf)s ideally suited for traditional dc measurement applications supporting a microprocessor and for ac signal processing applications interfacing to a digital signal processor. The [AD7654 i](http://analog.com/ad7654?doc=ad7654.pdf)s designed to interface with either a parallel 8-bit wide or 16-bit wide interface, a general-purpose serial port, or I/O ports on a microcontroller. A variety of external buffers can be used with th[e AD7654](http://analog.com/ad7654?doc=ad7654.pdf) to prevent digital noise from coupling into the ADC. The following section illustrates the use of the [AD7654 w](http://analog.com/ad7654?doc=ad7654.pdf)ith an SPI equipped DSP, the [ADSP-2191M.](http://analog.com/ADSP-2191M?doc=ad7654.pdf)

SPI INTERFACE [\(ADSP-2191M\)](http://analog.com/ADSP-2191M?doc=ad7654.pdf)

[Figure 35 s](#page-23-2)hows an interface diagram between th[e AD7654](http://analog.com/ad7654?doc=ad7654.pdf) and the SPI equippe[d ADSP-2191M.](http://analog.com/ADSP-2191M?doc=ad7654.pdf) To accommodate the slower speed of the DSP, the [AD7654 a](http://analog.com/ad7654?doc=ad7654.pdf)cts as a slave device and data must be read after conversion. This mode also allows the daisy-chain feature. The convert command can be initiated in response to an internal timer interrupt. The 32-bit output data is read with two serial peripheral interface (SPI) 16-bit wide accesses. The reading process can be initiated in response to the

end-of-conversion signal (BUSY going low) using an interrupt line of the DSP. By writing to the SPI control register (SPICLTx), the serial interface (SPI) on th[e ADSP-2191M i](http://analog.com/ADSP-2191M?doc=ad7654.pdf)s configured for master mode (MSTR) = 1, clock polarity bit $(CPOL) = 0$, clock phase bit $(CPHA) = 1$, and SPI interrupt enable $(TIMOD) = 00$. To meet all timing requirements, limit the SPI clock to 17 Mbps, allowing it to read an ADC result in less than 1 μs. When a higher sampling rate is desired, using one of the parallel interface modes is recommended.

APPLICATION HINTS **LAYOUT**

The [AD7654 h](http://analog.com/ad7654?doc=ad7654.pdf)as very good immunity to noise on the power supplies. However, care should still be taken with regard to grounding layout.

The printed circuit board that houses th[e AD7654 s](http://analog.com/ad7654?doc=ad7654.pdf)hould be designed so the analog and digital sections are separated and confined to certain areas of the board. This facilitates the use of ground planes that can be separated easily. Digital and analog ground planes should be joined in only one place, preferably underneath th[e AD7654,](http://analog.com/ad7654?doc=ad7654.pdf) or as close as possible to the [AD7654.](http://analog.com/ad7654?doc=ad7654.pdf) If th[e AD7654](http://analog.com/ad7654?doc=ad7654.pdf) is in a system where multiple devices require analog-to-digital ground connections, the connection should still be made at only a star ground point established as close as possible to th[e AD7654.](http://analog.com/ad7654?doc=ad7654.pdf)

Running digital lines under the device should be avoided because these couple noise onto the die. The analog ground plane should be allowed to run under the [AD7654](http://analog.com/ad7654?doc=ad7654.pdf) to avoid noise coupling. Fast switching signals like CNVST or clocks should be shielded with digital ground to avoid radiating noise to other sections of the board, and should never run near analog signal paths. Crossover of digital and analog signals should be avoided. Traces on different but close layers of the board should run at right angles to each other. This reduces the effect of crosstalk through the board.

The power supply lines to the [AD7654 s](http://analog.com/ad7654?doc=ad7654.pdf)hould use as large a trace as possible to provide low impedance paths and reduce the effect of glitches on the power supply lines. Good decoupling is

also important to lower the supply's impedance presented to the [AD7654 a](http://analog.com/ad7654?doc=ad7654.pdf)nd to reduce the magnitude of the supply spikes. Decoupling ceramic capacitors, typically 100 nF, should be placed on each power supply pin—AVDD, DVDD, and OVDD—close to, and ideally right up against these pins and their corresponding ground pins. Additionally, low ESR 10 μF capacitors should be located near the ADC to further reduce low frequency ripple.

The DVDD supply of th[e AD7654 c](http://analog.com/ad7654?doc=ad7654.pdf)an be a separate supply or can come from the analog supply AVDD or the digital interface supply OVDD. When the system digital supply is noisy or when fast switching digital signals are present, if no separate supply is available, the user should connect DVDD to AVDD through an RC filter (see [Figure 19\)](#page-14-0) and the system supply to OVDD and the remaining digital circuitry. When DVDD is powered from the system supply, it is useful to insert a bead to further reduce high frequency spikes.

The [AD7654 h](http://analog.com/ad7654?doc=ad7654.pdf)as five different ground pins: INGND, REFGND, AGND, DGND, and OGND. INGND is used to sense the analog input signal. REFGND senses the reference voltage and, because it carries pulsed currents, should be a low impedance return to the reference. AGND is the ground to which most internal ADC analog signals are referenced; it must be connected with the least resistance to the analog ground plane. DGND must be tied to the analog or digital ground plane, depending on the configuration. OGND is connected to the digital system ground.

OUTLINE DIMENSIONS

Dimensions shown in millimeters

ORDERING GUIDE

1 Z = RoHS Compliant Part

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